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Data Sheet	October 2013

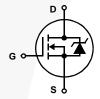
N-Channel UltraFET Power MOSFET 60 V, 17 A, 71 m Ω

Packaging

JEDEC TO-252AA



Symbol



Features

- Ultra Low On-Resistance
 - $r_{DS(ON)} = 0.063\Omega$, $V_{GS} = 10V$
 - $r_{DS(ON)} = 0.071\Omega$, $V_{GS} = 5V$
- Simulation Models
 - Temperature Compensated PSPICE[®] and SABER[©] Electrical Models
 - Spice and SABER[©] Thermal Impedance Models
 - www.fairchildsemi.com
- · Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Switching Time vs RGS Curves

Ordering Information

PART NUMBER	PACKAGE	BRAND
RFD12N06RLESM9A	TO-252AA	12N6LE

Absolute Maximum Ratings T_C = 25°C, Unless Otherwise Specified

	RFD12N06RLESM9A	UNITS
Drain to Source Voltage (Note 1)	60	V
Drain to Gate Voltage ($R_{GS} = 20k\Omega$) (Note 1)	60	V
Gate to Source Voltage	±16	V
Drain Current		
Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 5V$)	17	Α
Continuous (T _C = 25 ^o C, V _{GS} = 10V) (Figure 2)	18	Α
Continuous (T_C = 135 $^{\circ}$ C, V_{GS} = 5 V) I_D	8	Α
Continuous (T_C = 135 $^{\circ}$ C, V_{GS} = 4.5 $^{\circ}$ V) (Figure 2)	8	Α
Pulsed Drain Current	Figure 4	
Pulsed Avalanche Rating UIS	Figures 6, 17, 18	
Power Dissipation	49	W
Derate Above 25°C	0.327	W/oC
Operating and Storage Temperature	-55 to 175	οС
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10s	300	оС
Package Body for 10s, See Techbrief TB334T _{pkg}	260	οС
NOTE:		

1. $T_J = 25^{\circ}C$ to $150^{\circ}C$.

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

RFD12N06RLESM

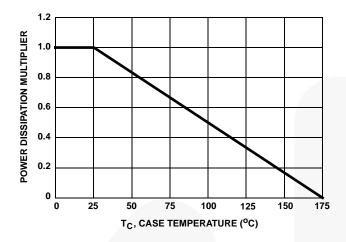
Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN	TYP	MAX	UNITS
OFF STATE SPECIFICATIONS	+			<u> </u>	+		+
Drain to Source Breakdown Voltage	BV _{DSS}	$I_D = 250 \mu A, V_{GS} = 0$	V (Figure 12)	60	-	-	V
		$I_D = 250 \mu A, V_{GS} = 0$	V , T _C = -40 ^o C (Figure 12)	55	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 55V, V_{GS} = 0V$	V	-	-	1	μΑ
		$V_{DS} = 50V, V_{GS} = 0V$	V, T _C = 150 ^o C	-	-	250	μΑ
Gate to Source Leakage Current	I _{GSS}	$V_{GS} = \pm 16V$		-	-	±100	nA
ON STATE SPECIFICATIONS							Ш
Gate to Source Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D} = 250$	μA (Figure 11)	1	-	3	V
Drain to Source On Resistance	r _{DS(ON)}	I _D = 18A, V _{GS} = 10V	(Figures 9, 10)	-	0.052	0.063	Ω
	, ,	I _D = 8A, V _{GS} = 5V (F	igure 9)	-	0.060	0.071	Ω
		I _D = 8A, V _{GS} = 4.5V		-	0.064	0.075	Ω
THERMAL SPECIFICATIONS	+			1	+	1	+
Thermal Resistance Junction to Case	$R_{\theta JC}$	TO-252AA		-	-	3.06	oC/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	_		-	-	100	oC/W
SWITCHING SPECIFICATIONS (VGS	= 4.5V)						
Turn-On Time	ton	$V_{DD} = 30V, I_D = 8A$		-	-	153	ns
Turn-On Delay Time	t _d (ON)	$V_{GS} = 4.5V, R_{GS} = 2$	22Ω	-	13	-	ns
Rise Time	t _r	(Figures 15, 21, 22)		-	89	-	ns
Turn-Off Delay Time	t _{d(OFF)}			-	22	-	ns
Fall Time	t _f			-	37	-	ns
Turn-Off Time	tOFF			-	-	89	ns
SWITCHING SPECIFICATIONS (VGS	-						
Turn-On Time	ton	V _{DD} = 30V, I _D = 18A		-	-	59	ns
Turn-On Delay Time	t _d (ON)	$V_{GS} = 10V$, $R_{GS} = 24\Omega$ (Figures 16, 21, 22)		-	5.3	-	ns
Rise Time	t _r			-	34	-	ns
Turn-Off Delay Time	t _{d(OFF)}			-	41	-	ns
Fall Time	t _f			-	50	-	ns
Turn-Off Time	tOFF				-	136	ns
GATE CHARGE SPECIFICATIONS	0			/			
Total Gate Charge	Q _{g(TOT)}	V _{GS} = 0V to 10V	V _{DD} = 30V,	-	12	15	nC
Gate Charge at 5V	Q _{g(5)}	$V_{GS} = 0V \text{ to } 1V$	-	6.8	8.2	nC	
Threshold Gate Charge	Q _{g(TH)}		-	0.54	0.65	nC	
Gate to Source Gate Charge	Q _{gs}		-	1.7	-	nC	
Gate to Drain "Miller" Charge	Q _{gd}			-	3	-	nC
CAPACITANCE SPECIFICATIONS	gu						
Input Capacitance	C _{ISS}	V _{DS} = 25V, V _{GS} = 0V	٧,	-	485	-	pF
Output Capacitance	C _{OSS}	f = 1MHz		_	130	-	pF
Reverse Transfer Capacitance	C _{RSS}	(Figure 13)		-	28	_	pF
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Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	V_{SD}	I _{SD} = 8A	-	-	1.25	V
		I _{SD} = 4A	-	-	1.0	V
Reverse Recovery Time	t _{rr}	$I_{SD} = 8A$, $dI_{SD}/dt = 100A/\mu s$	-	-	70	ns
Reverse Recovered Charge	Q _{RR}	$I_{SD} = 8A$, $dI_{SD}/dt = 100A/\mu s$	-	ī	165	nC

Typical Performance Curves





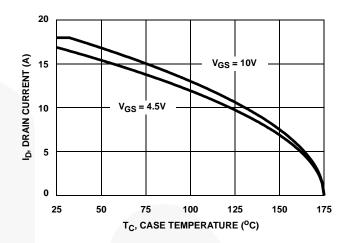


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

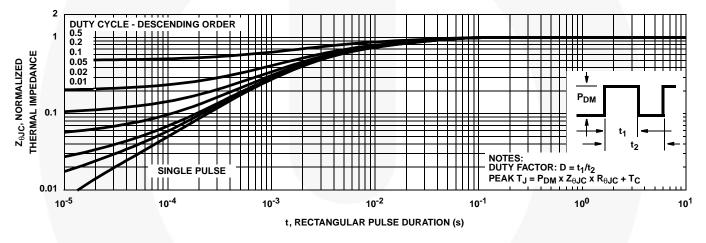


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

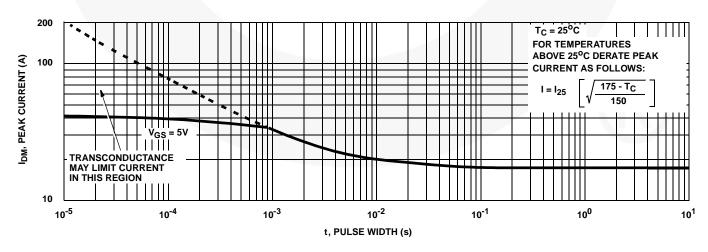


FIGURE 4. PEAK CURRENT CAPABILITY

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Typical Performance Curves (Continued)

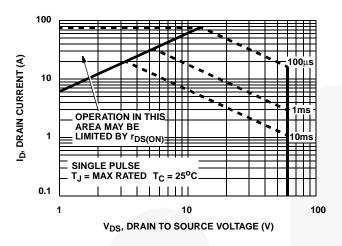


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

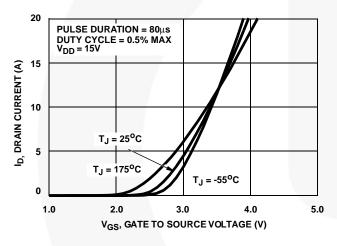


FIGURE 7. TRANSFER CHARACTERISTICS

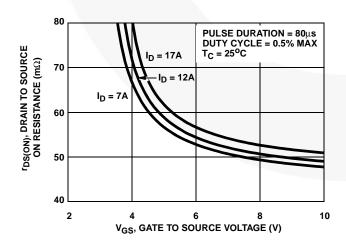
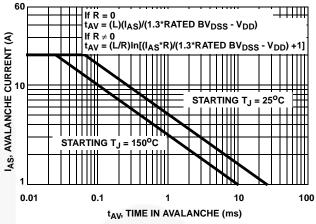


FIGURE 9. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT



NOTE: Refer to Fairchild Application Notes AN9321 and AN9322.

FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

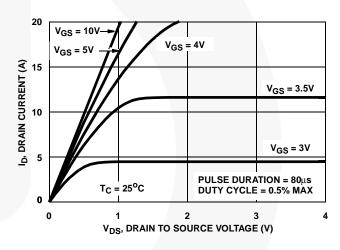


FIGURE 8. SATURATION CHARACTERISTICS

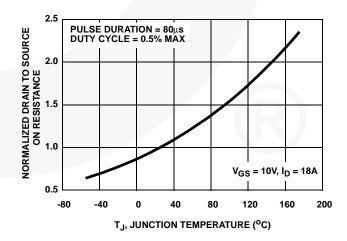


FIGURE 10. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

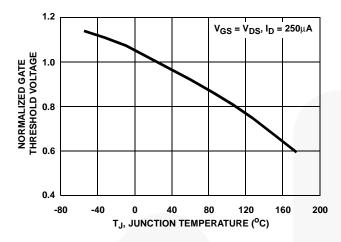


FIGURE 11. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

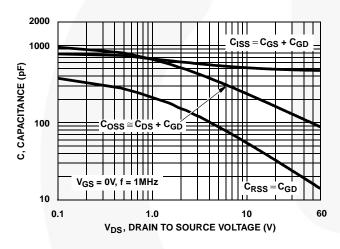


FIGURE 13. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

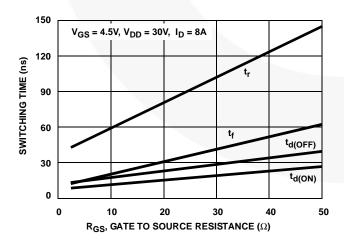


FIGURE 15. SWITCHING TIME vs GATE RESISTANCE

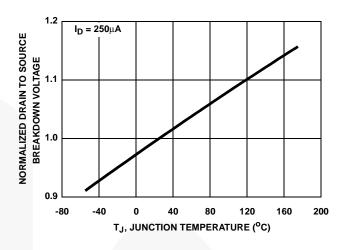
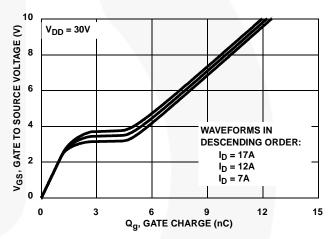


FIGURE 12. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE



NOTE: Refer to Fairchild Application Notes AN7254 and AN7260.

FIGURE 14. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

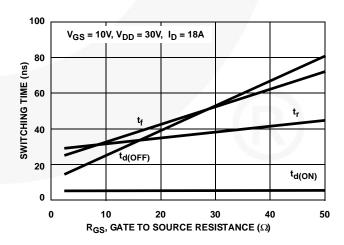


FIGURE 16. SWITCHING TIME vs GATE RESISTANCE

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Test Circuits and Waveforms

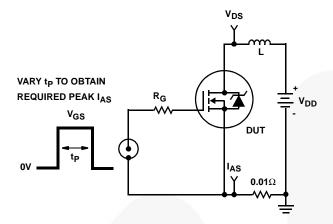


FIGURE 17. UNCLAMPED ENERGY TEST CIRCUIT

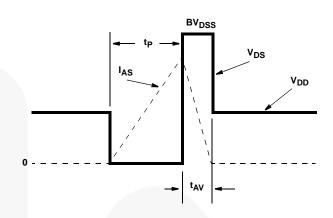


FIGURE 18. UNCLAMPED ENERGY WAVEFORMS

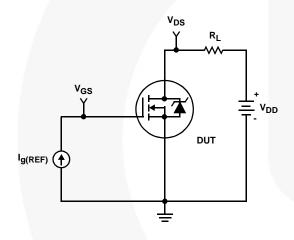


FIGURE 19. GATE CHARGE TEST CIRCUIT

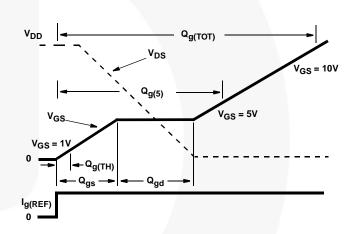


FIGURE 20. GATE CHARGE WAVEFORMS

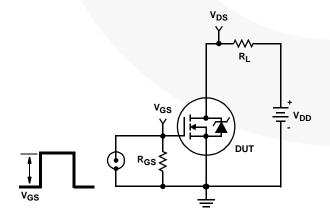


FIGURE 21. SWITCHING TIME TEST CIRCUIT

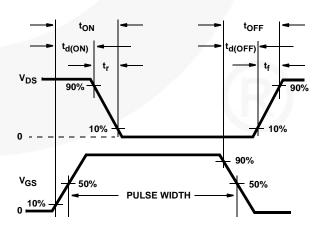
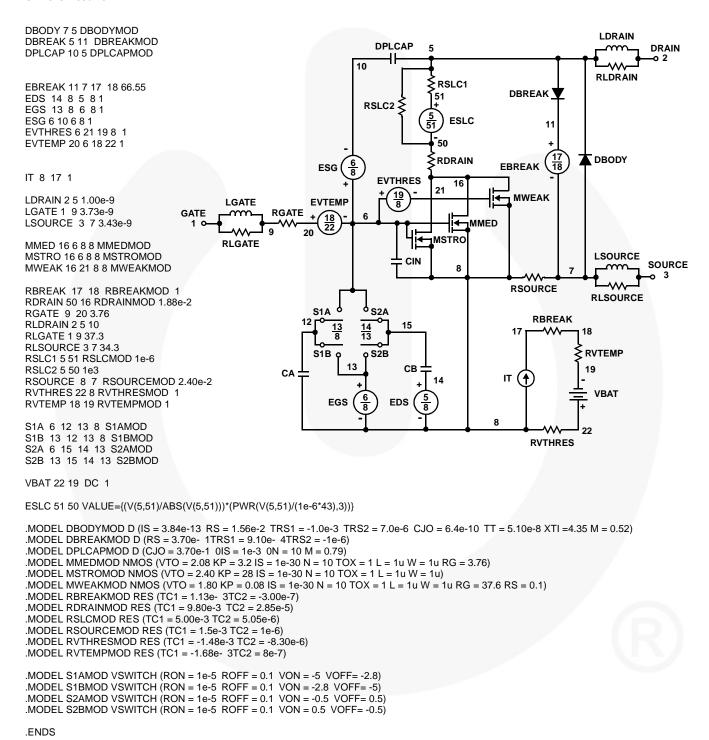


FIGURE 22. SWITCHING TIME WAVEFORM

PSPICE Electrical Model

.SUBCKT HUF76409D 2 1 3; rev 23 August 1999

CA 12 8 6.30e-10 CB 15 14 6.30e-10 CIN 6 8 4.60e-10



NOTE: For further discussion of the PSPICE model, consult **A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options**; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.

SABER Electrical Model

```
REV 23 August 1999
template huf76409d n2,n1,n3
electrical n2,n1,n3
var i iscl
d..model dbodymod = (is = 3.84e-13, cjo = 6.40e-10, tt = 5.10e-8, xti = 4.35, m = 0.52)
d..model dbreakmod = ()
d..model dplcapmod = (cjo = 3.70e-10, is = 1e-30, m = 0.79)
m..model mmedmod = (type=_n, vto = 2.08, kp = 3.2, is = 1e-30, tox = 1)
m..model mstrongmod = (type=_n, vto = 2.40, kp = 28, is = 1e-30, tox = 1)
m..model mweakmod = (type=_n, vto = 1.80, kp = 0.08, is = 1e-30, tox = 1)
                                                                                                                                   LDRAIN
sw_vcsp..model s1amod = (ron = 1e-5, roff = 0.1, von = -5, voff = -2.8)
                                                                                   DPLCAP
                                                                                                                                              DRAIN
sw_vcsp..model s1bmod = (ron =1e-5, roff = 0.1, von = -2.8, voff = -5)
                                                                                10
sw_vcsp..model s2amod = (ron = 1e-5, roff = 0.1, von = -0.5, voff = 0.5)
                                                                                                                                  RLDRAIN
sw_vcsp..model s2bmod = (ron = 1e-5, roff = 0.1, von = 0.5, voff = -0.5)
                                                                                                 RSLC1
                                                                                                             RDBREAK
c.ca n12 n8 = 6.30e-10
                                                                                 RSLC2 ≥
c.cb n15 n14 = 6.30e-10
                                                                                                                                  RDBODY
                                                                                                   ISCL
c.cin n6 n8 = 4.60e-10
                                                                                                               DBREAK
d.dbody n7 n71 = model=dbodymod
                                                                                                RDRAIN
d.dbreak n72 n11 = model=dbreakmod
                                                                             6
8
                                                                       ESG
                                                                                                                       11
d.dplcap n10 n5 = model=dplcapmod
                                                                                    EVTHRES
                                                                                                    16
                                                                                                21
                                                                                       1<u>9</u>
8
                                                                                                                 MWEAK
i.it n8 n17 = 1
                                                    LGATE
                                                                      EVTEMP
                                                                                                                                  DBODY
                                                              RGATE
                                           GATE
                                                                                                                 EBREAK
I.ldrain n2 n5 = 1.00e-9
                                                                                                      MMED
                                                             9
                                                                    20
1.1gate n1 n9 = 3.73e-9
                                                                                            I<del><</del>_MSTR
                                                   RLGATE
I.Isource n3 n7 = 3.43e-9
                                                                                                                                  LSOURCE
                                                                                          CIN
                                                                                                                                             SOURCE
                                                                                                     8
m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u
                                                                                                                RSOURCE
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u
                                                                                                                                 RLSOURCE
                                                                                 S2A
res.rbreak n17 n18 = 1, tc1 = 1.13e-3, tc2 = -3.00e-7
                                                                                                                     RBREAK
res.rdbody n71 n5 = 1.56e-2, tc1 = -1.0e-3, tc2 = 7.00e-6
                                                                                                                 17
res.rdbreak n72 n5 = 3.70e-1, tc1 = 9.10e-4, tc2 = -1e-6
                                                                                                                                RVTEMP
res.rdrain n50 n16 = 1.88e-2, tc1 = 9.80e-3, tc2 = 2.85e-5
                                                                                 o S2B
res.rgate n9 n20 = 3.76
                                                                                          CB
                                                                CA
res.rldrain n2 n5 = 10
                                                                                                               ΙT
res.rlgate n1 n9 = 37.3
                                                                                                                                  VBAT
res.rlsource n3 n7 = 34.3
                                                                          EGS
                                                                                      EDS
res.rslc1 n5 n51= 1e-6, tc1 = 5.00e-3, tc2 = 5.05e-6
                                                                                                             8
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7 = 2.40e-2, tc1 = 1.5e-3, tc2 =1e-6
                                                                                                                    RVTHRES
res.rvtemp n18 n19 = 1, tc1 = -1.68e-3, tc2 = 8.00e-7
res.rvthres n22 n8 = 1, tc1 = -1.48e-3, tc2 = -8.30e-6
spe.ebreak n11 n7 n17 n18 = 66.55
spe.eds n14 n8 n5 n8 = 1
spe.egs n13 n8 n6 n8 = 1
spe.esg n6 n10 n6 n8 = 1
spe.evtemp n20 n6 n18 n22 = 1
spe.evthres n6 n21 n19 n8 = 1
sw_vcsp.s1a n6 n12 n13 n8 = model=s1amod
sw_vcsp.s1b n13 n12 n13 n8 = model=s1bmod
sw_vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw_vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
i (n51->n50) +=iscl
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/43))**3))
```

SPICE Thermal Model

REV 10 September 1999

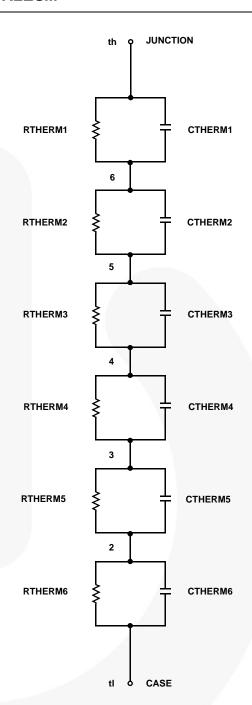
HUF76409T

CTHERM1 th 6 9.50e-4
CTHERM2 6 5 2.40e-3
CTHERM3 5 4 3.90e-3
CTHERM4 4 3 4.10e-3
CTHERM5 3 2 5.60e-3
CTHERM6 2 tl 4.00e-2
RTHERM1 th 6 2.00e-2
RTHERM2 6 5 1.10e-1
RTHERM3 5 4 2.75e-1
RTHERM4 4 3 5.53e-1
RTHERM5 3 2 7.25e-1
RTHERM6 2 tl 7.56e-1

SABER Thermal Model

SABER thermal model HUF76409T

```
template thermal_model th tl thermal_c th, tl { ctherm.ctherm1 th 6=9.50e\text{-}4 ctherm.ctherm2 6.5=2.40e\text{-}3 ctherm.ctherm3 5.4=3.90e\text{-}3 ctherm.ctherm4 4.3=4.10e\text{-}3 ctherm.ctherm5 3.2=5.60e\text{-}3 ctherm.ctherm6 2.10e\text{-}2 rtherm.rtherm1 th 6=2.00e\text{-}2 rtherm.rtherm2 6.5=1.10e\text{-}1 rtherm.rtherm3 5.4=2.75e\text{-}1 rtherm.rtherm4 4.3=5.53e\text{-}1 rtherm.rtherm5 3.2=7.25e\text{-}1 rtherm.rtherm6 2.11=7.56e\text{-}1
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Marking Small Speakers Sound Louder and Better™

MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™

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